



Product Change Notification

111444 - 02

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111444 - 02
Change Title: Intel® Desktop Board DH77EB, Boxed and Bulk
PCN 111444-02, Product Design
PCB FAB Change
Reason for Revision: The PCB Change has not yet implemented and an update will be provided at a future date.
Date of Publication: December 26, 2012

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	TBD
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Description of Change to the Customer:

Reason for Revision: The PCB Change has not yet implemented and an update will be provided at a future date.

The printed circuit board will be changed to enhance operation, including changing control of the chassis intrusion signal from the Super I/O controller to the Intel H77 Express Platform Controller Hub.

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only: No changes to form, fit, or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change AA	Post Change AA
BOXDH77EB	918162	G39073-304	G39073-400
BLKDH77EB	918163	G39073-304	G39073-400

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
April 13, 2012	00	Originally Published PCN
August 15, 2012	01	Revise Milestone Date
December 26, 2012	02	The PCB Change has not yet implemented and an update will be provided at a future date.